

MGFC42V6472A

6.4 - 7.2GHz BAND 16W INTERNALLY MATCHED GaAs FET

DESCRIPTION

The MGFC42V6472A is an internally impedance matched GaAs power FET especially designed for use in 6.4 - 7.2 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

FEATURES

- Internally matched to 50 ohm system
- High output power
P1dB = 16W (TYP.) @ f=6.4 - 7.2 GHz
- High power gain
GLP =8.0 dB (TYP.) @ f=6.4 - 7.2 GHz
- High power added efficiency
P.A.E. = 31 % (TYP.) @ f=6.4 - 7.2 GHz
- Low Distortion[Item-51]
IM3=-45 dBc(TYP.)@Po=31.0dBm S.C.L.

APPLICATION

- item 01 : 6.4 - 7.2 GHz band power amplifier
- item 51 : 6.4 - 7.2 GHz band digital radio communication

QUALITY GRADE

IG

RECOMMENDED BIAS CONDITIONS

- $V_{DS} = 10$ (V)
- ID = 4.5 (A)
- Rg=25 (ohm) Refer to Bias Procedure

ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Ratings | Unit |
|--------|-------------------------|------------|-------|
| VGDO | Gate to drain voltage | -15 | V |
| VGSO | Gate to source voltage | -15 | V |
| ID | Drain current | 15 | A |
| IGR | Reverse gate current | -40 | mA |
| IGF | Forward gate current | 84 | mA |
| PT | Total power dissipation | 93.7 | W |
| Tch | Channel temperature | 175 | deg.C |
| Tstg | Storage temperature | -65 / +175 | deg.C |

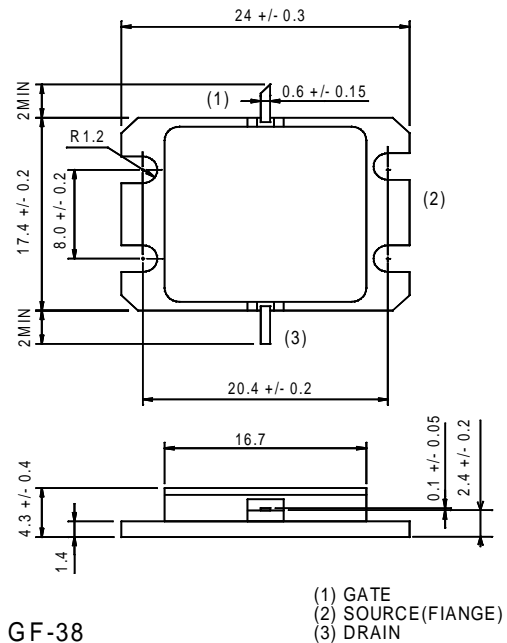
*1 : Tc=25 Deg.C

ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Test conditions | Limits | | | Unit |
|-----------|--------------------------------------|--|-----------------|------|-----|------|
| | | | Min | Typ | Max | |
| IDSS | Saturated drain current | VDS = 3V , VGS = 0V | - | 9 | 12 | A |
| Gm | Transconductance | VDS = 3V , ID = 4.4A | - | 4 | - | S |
| VGS(off) | Gate to source cut-off voltage | VDS = 3V , ID = 80mA | -2 | -3 | -4 | V |
| P1dB | Output power at 1dB gain compression | VDS=10V, ID(RF off)=4.5A, f=6.4-7.2GHz | 41.5 | 42.5 | - | dBm |
| GLP | Linear power gain | | 7 | 8 | - | dB |
| ID | Drain current | | - | 4.5 | - | A |
| PAE | Power added efficiency | | - | 31 | - | % |
| IM3 | 3rd order IM distortion *1 | | -42 | -45 | - | dBc |
| Rth(ch-c) | Thermal resistance *2 | | Delta Vf method | - | - | 1.6 |

*1 : item -51, 2 tone test, Po=31.0dBm Single Carrier Level, f=7.2GHz, Delta f=10MHz *2 : Channel-case

OUTLINE DRAWING Unit: millimeters (inches)



< Keep safety first in your circuit designs! >

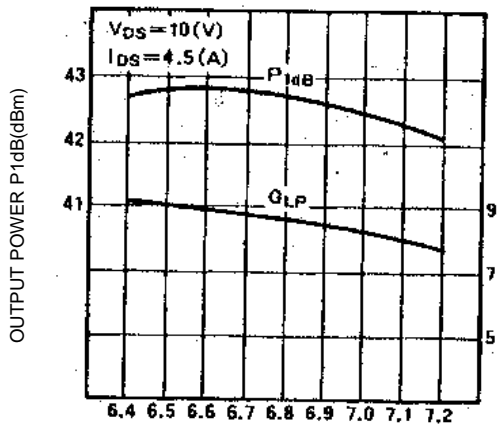
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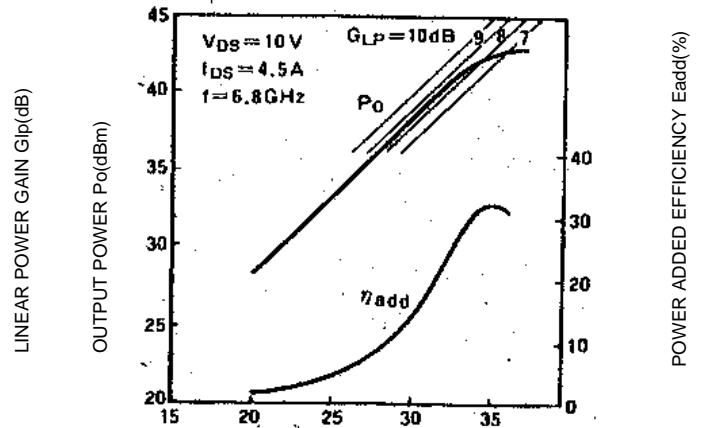
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TYPICAL CHARACTERISTICS (Ta=25 Deg.C)

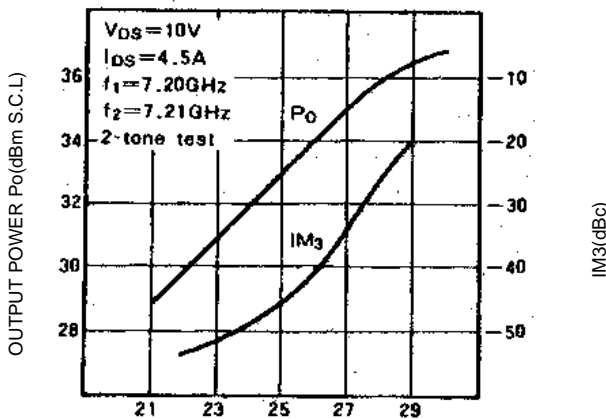
P1dB, G_{LP} VS. f



P_o, E_{add} VS. P_{in}



P_o, IM₃ VS. P_{in}



S PARAMETERS (Ta=25 Deg.C, V_{DS}=10V, I_{DS}=4.5A)

| f (GHz) | S Parameters (TYP.) | | | | | | | |
|------------|---------------------|-------------|-----------------|-------------|-----------------|-------------|-----------------|-------------|
| | S ₁₁ | | S ₂₁ | | S ₁₂ | | S ₂₂ | |
| | Magn. | Angle(deg.) | Magn. | Angle(deg.) | Magn. | Angle(deg.) | Magn. | Angle(deg.) |
| 6.40 | 0.35 | 57 | 2.98 | -113 | 0.078 | -159 | 0.29 | 113 |
| 6.50 | 0.29 | 36 | 2.95 | -132 | 0.080 | -176 | 0.36 | 97 |
| 6.60 | 0.22 | 22 | 2.87 | -149 | 0.082 | 167 | 0.41 | 83 |
| 6.70 | 0.16 | 7 | 2.80 | -166 | 0.082 | 153 | 0.46 | 70 |
| 6.80 | 0.09 | -7 | 2.73 | 177 | 0.080 | 136 | 0.50 | 61 |
| 6.90 | 0.01 | -43 | 2.63 | 162 | 0.078 | 123 | 0.52 | 54 |
| 7.00 | 0.08 | 144 | 2.54 | 145 | 0.080 | 105 | 0.53 | 47 |
| 7.10 | 0.14 | 134 | 2.46 | 135 | 0.074 | 92 | 0.52 | 41 |
| 7.20 | 0.24 | 121 | 2.37 | 119 | 0.072 | 85 | 0.51 | 34 |

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